

#### High-reliability discrete products and engineering services since 1977

### 1N5802-1N5806

### HIGH EFFICIENCY RECTIFIERS

#### **FEATURES**

- Available as "HR" (high reliability) screened per MIL-PRF-19500, JANTX level. Add "HR" suffix to base part number.
- Available as non-RoHS (Sn/Pb plating), standard, and as RoHS by adding "-PBF" suffix.

#### **MAXIMUM RATINGS**

Parameter	Symbol	Value	Unit
Working peak reverse voltage			
1N5802		50	
1N5803	$V_{RWM}$	75	V
1N5804	V <sub>RWM</sub>	100	V
1N5805		125	
1N5806		150	
Forward surge current (1)	I <sub>FSM</sub>	35	Α
Average rectified output current @ T <sub>L</sub> = 75°C at 3/8" lead length (2)	I <sub>01</sub>	2.5	Α
Average rectified output current @ T <sub>A</sub> = 55°C at 3/8" lead length (3)	I <sub>02</sub>	1.0	Α
Capacitance @ $V_R = 10V$ , $f = 1MHz$ , $V_{sig} = 50mV(p-p)$	С	25	pF
Reverse recovery time (4)	t <sub>rr</sub>	25	ns
Solder temperature @ 10 s	T <sub>SP</sub>	260	°C
Junction and storage temperature range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +175	°C
Thermal resistance junction to lead (L = 0.375")	R <sub>OJL</sub>	36	°C/W

Note 1:  $T_A = 25^{\circ}C$  @  $I_O = 1.0A$  and  $V_{RWM}$  for 10 8.3ms surges at 1 minute intervals.

Note 2:  $I_{01}$  is rated at 2.5A @  $T_L = 75^{\circ}$ C at 3/8" lead length. Derate at 25mA/°C for  $T_L$  above 75°C.

Note 3:  $l_{02}$  is rated at 1.0A @  $T_A$  = 55°C for PC boards where thermal resistance from mounting point t ambient is sufficiently controlled ( $R_{DIX}$  < 154°C/W) where  $T_{I(max)}$  175°C is not exceeded.

Derate at 8.33mA/°C for  $T_A$  above 55°C. Note 4:  $I_F = 0.5A$ ,  $I_{RM} = 0.5A$ ,  $I_{R(REC)} = 0.05A$ .

#### **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise specified)

Part number	Minimum breakdown voltage @ 100μA	Maximum forward voltage $V_{\text{FM}}$		Maximum reverse current @ V <sub>RWM</sub>		Maximum surge current <sup>(5)</sup>	Maximum reverse recovery time <sup>(6)</sup>	Thermal impedance @ t <sub>H</sub> = 10ms <sup>(7)</sup>
	V <sub>(BR)</sub>					I <sub>FSM</sub>	t <sub>rr</sub>	Z <sub>eJX</sub>
	Volts	Vo	olts	Ļ	μΑ			9C // A/
		I <sub>F</sub> = 1.0A	I <sub>F</sub> = 2.5A	25°C	125°C	Amps	ns	°C/W
1N5802	60	0.875	0.975	1	175	35	25	4.0
1N5803	85	0.875	0.975	1	175	35	25	4.0
1N5804	110	0.875	0.975	1	175	35	25	4.0
1N5805	135	0.875	0.975	1	175	35	25	4.0
1N5806	160	0.875	0.975	1	175	35	25	4.0

Note 5:  $T_A=2.5^{\circ}C$  @  $I_O=1.0A$  and  $V_{RWM}$  for ten 8.3ms surges at 1 minute intervals. Note 6:  $I_F=0.5A$ ,  $I_{RM}=0.5A$ ,  $I_{R(REC)}=0.05A$ . Note 7: See figure 1 for thermal impedance curve.



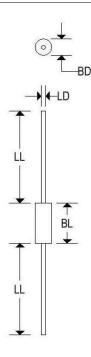
High-reliability discrete products and engineering services since 1977

## 1N5802-1N5806

### HIGH EFFICIENCY RECTIFIERS

#### MECHANICAL CHARACTERISTICS

Case	Digi A
Marking	Alpha Numeric
Polarity	Cathode Band



	Digi A					
	Inc	hes	Millimeters			
	Min	Max	Min	Max		
BD	-	0.095	±.	2.413		
BL	-	0.180	4	4.572		
LD	0.028	0.032	0.711	0.813		
LL	0.700	-	17.800	-		



# High-reliability discrete products and engineering services since 1977

## 1N5802-1N5806

### HIGH EFFICIENCY RECTIFIERS

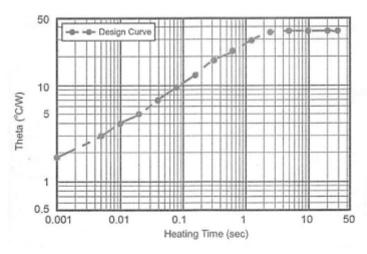


FIGURE 1 Maximum Thermal Impedance

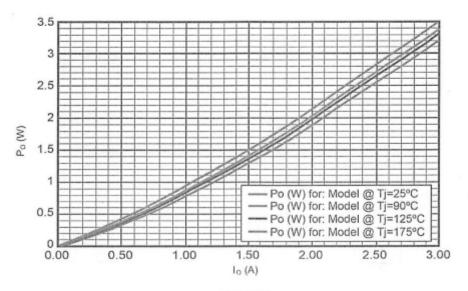


FIGURE 2

Rectifier Power vs I<sub>O</sub> (Average Forward Current)



# High-reliability discrete products and engineering services since 1977

## 1N5802-1N5806

### HIGH EFFICIENCY RECTIFIERS

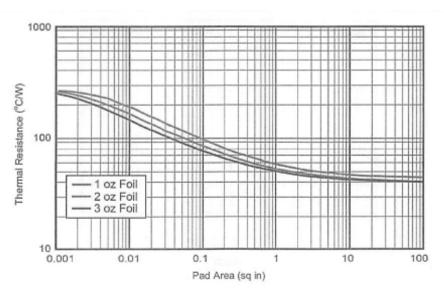


FIGURE 3
Thermal Resistance vs FR4 Pad Area At Ambient
PCB horizontal (for each pad) with 1, 2, and 3 oz copper

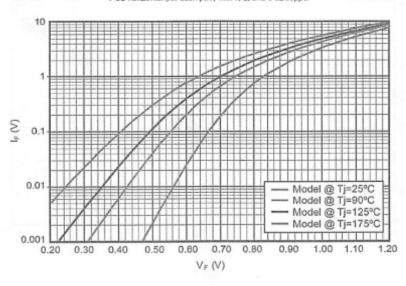


FIGURE 4
Forward Voltage vs Forward Current